

DOCKET NO. 4459-118

03-24-2003



102397616

To the Honorable Commissioner of Patents and Trademarks: Please receive original documents or copy thereto:

1. Name of conveying party(ies):

- 1. Yueh Lung LIN
- 2. Ho Ming TONG
- 3. Yao Hsin FENG
- 4. Su TAO
- 5. Chi Cheng PAN
- 6. Kuo Pin YANG
- 7. Sung Ching HUNG

3.12.03

2. Name and address of receiving party(ies):

Name: **ADVANCED SEMICONDUCTOR ENGINEERING, INC.**

Internal Address:

Street Address: **No. 26, Chin 3rd Road, Nantze Export Processing Zone, Kaoshiung**

City: **Taiwan**

State:

Zip:

Country: **R.O.C.**

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date **December 20, 2002**

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

20385565

If the document is being filed together with a new application, the execution date of the application is: December 20, 2002

A. Patent Application No(s).
filed

B. Patent No(s).
issued

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name:

LOWE HAUPTMAN GILMAN & BERNER

Internal Address:

Street Address: **1700 Diagonal Road, Suite 310**

City: **Alexandria**

State: **VA**

Zip: **22314**

6. Total number of applications and patents involved: **one**

7. Total fee (37 CFR 3.41). \$ 40.00

- Enclosed
- Authorized to be charged to deposit account
- Credit Card payment form enclosed

8. Deposit account number: 07-1337

DO NOT USE THIS SPACE

9. Signature.

Benjamin J. Hauptman, 29,310

Name of Person, Registration No.

[Signature]
Signature

March 12, 2003

Date

Total number of pages including cover sheet, attachment, and document: **3**

CMB No. 0851-0011 (exp. 4/94)

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FC:8021

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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|--------------------------|----------------------------|
| (1) <u>Yueh Lung LIN</u> | (4) <u>Su TAO</u> |
| (2) <u>Ho Ming TONG</u> | (5) <u>Chi Cheng PAN</u> |
| (3) <u>Yao Hsin FENG</u> | (6) <u>Kuo Pin YANG</u> |
| | (7) <u>Sung Ching HUNG</u> |

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Advanced Semiconductor Engineering, Inc.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SEMICONDUCTOR WAFER AND TESTING METHOD FOR THE SAME

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or
- (b) for which an application for United States Letters Patent was executed on December 20, 2002,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside our signatures:

INVENTORS	DATE SIGNED
1) Signature: <u><i>Yueh Lung Lin</i></u> Name: Yueh Lung LIN	<u>December 20, 2002</u>
2) Signature: <u><i>Ho Ming Tong</i></u> Name: Ho Ming TONG	<u>December 20, 2002</u>
3) Signature: <u><i>Yao Hsin Feng</i></u> Name: Yao Hsin FENG	<u>December 20, 2002</u>
4) Signature: <u><i>Su Tao</i></u> Name: Su TAO	<u>December 20, 2002</u>
5) Signature: <u><i>Chi Cheng Pan</i></u> Name: Chi Cheng PAN <i>Chi</i>	<u>December 20, 2002</u>

6) Signature: Kuo Pin Yang
Name: Kuo Pin YANG

December 20, 2002

7) Signature: Sung Ching Hung
Name: Sung Ching HUNG

December 20, 2002